

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

AXEL PREUSSE
MARKUS NOPPER
HOLGER SCHÜHRER

Serial No.: 10/747,722

Confirmation No.: 5854

Filed: December 29, 2003

For: METHOD OF REDUCING WAFER
CONTAMINATION BY REMOVING
UNDER-METAL LAYERS AT THE
WAFER EDGE

Patent No.: 7,169,664 B2

Issued: January 30, 2007

Examiner: Edward Joseph Wojciechowicz

Group Art Unit: 2815

Att'y Docket: 2000.109700/DE0351

Customer No.: 23720

REQUEST FOR CERTIFICATE OF CORRECTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

The patentee requests a certificate of correction for Patent and Trademark Office ("PTO") errors pursuant to 37 C.F.R. § 1.322. Because these errors were the PTO's, no fee should be required. If any fee is required, please charge Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.109700.

The following errors are listed on the attached form PTO-1050.

Col. 10, line 10 (claim 5, line 2), delete "comprises copper and".

Col. 10, line 39 (claim 11, line 8), after "barrier layer" insert -- comprising tantalum --.

Col. 10, line 40 (claim 11, line 9), after "layer" insert -- comprising copper --.

Col. 10, line 43 (claim 11, line 12), change "applyingi" to -- applying --.

Respectfully submitted,

WILLIAMS, MORGAN & AMERSON
CUSTOMER NO. 23720

Date: February 6, 2007

/J. Mike Amerson/

J. Mike Amerson
Reg. No. 35,426
10333 Richmond, Suite 1100
Houston, Texas 77042
(713) 934-4055
(713) 934-7011 (facsimile)

ATTORNEY FOR APPLICANTS

UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO. : 7,169,664 B2
 DATED : January 30, 2007
 INVENTOR(S) : Axel Preusse, Markus Nopper and Holger Schührer

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Col. 10, line 10 (claim 5, line 2), delete "comprises copper and".

Col. 10, line 39 (claim 11, line 8), after "barrier layer" insert -- comprising tantalum --.

Col. 10, line 40 (claim 11, line 9), after "layer" insert -- comprising copper --.

Col. 10, line 43 (claim 11, line 12), change "applyingi" to -- applying --.

MAILING ADDRESS OF SENDER:
 J. Mike Amerson
 WILLIAMS, MORGAN & AMERSON, P.C.
 10333 Richmond, Suite 1100
 Houston, Texas 77042

PATENT NO. 7,169,664 B2
 No. of add'l. copies
 @ 50¢ per page
 ➡ _____